

RB751S40

SURFACE MOUNT SCHOTTKY DIODES CURRENT

300 mA

VOLTAGE 40 Volt

FEATURES

- Extremely fast switching speed
- Very Low V_F : 0.325V (Typ) at I_F = 1mA
- · Surface mount package ideally suited for autmatic insertion
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. . (Halogen Free)

SOD-523 0.050(1.25) 0.045(1.15) 0.014(0.35) 0.034(0.85) 0.026(0.65) 0.006(0.15) 0.067(1.70) .0.20 MIN.

Unit : inch(mm)

MECHANICAL DATA

- Case: SOD-523, Plastic
- Terminals: Solderable per MIL-STD-750, Method 2026
- Appox Weight: 0.00005 ounces, 0.0014 grams
- Marking: 51

ABSOLUTE RATINGS

Parameter	Symbol	Value	Units	
Maximum Reverse DC Voltage	V _{RRM}	40	V	
Peak Reverse Voltage	V _R	30	V	
Maximum Forward Current	I _{F(AV)}	0.3	А	
Power Dissipation ⁽¹⁾	P _{TOT}	0.2	W	
Peak Forward Surge Current at t=8.3ms	I _{FSM}	500	mA	
Junction Temperature Range	TJ	-55 to + 125	°C	
Storage Temperature Range	T _{stg}	-55 to + 125	°C	

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Units
Thermal Resistance, Junction to Ambient (1)	R _{eja}	500	°C/W

1. FR-4 Board = 70 x 60 x 1mm. Minmum Pad Layout



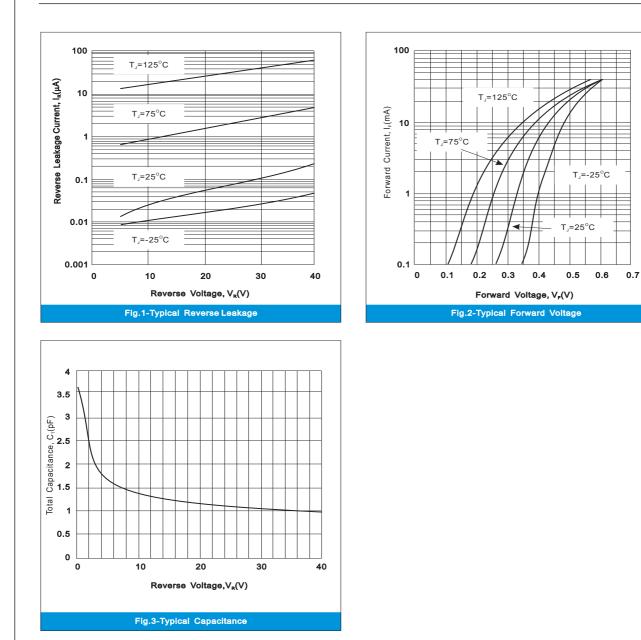


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ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Units
Reverse Leakage Current	I _R	V _R =30V	-	-	0.5	uA
Forward Voltage	V _F	I _F =1mA	-	-	0.37	V
Total Capacitance	C _T	$V_{R} = 1 V, F = 1 M H_{Z}$	-	3	5	рF

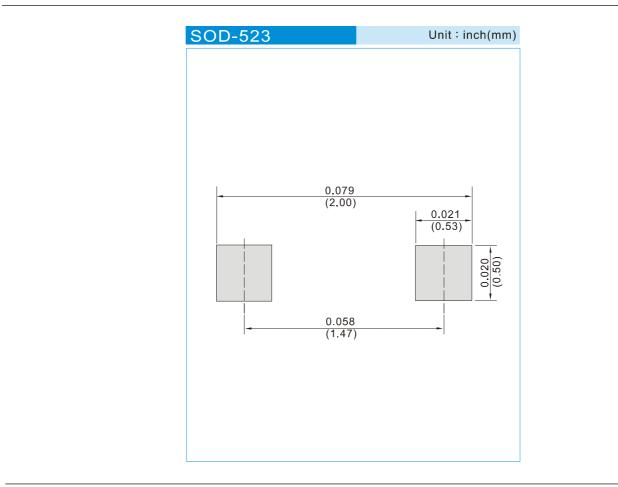
ELECTRICAL CHARACTERISTICS CURVE





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MOUNTING PAD LAYOUT



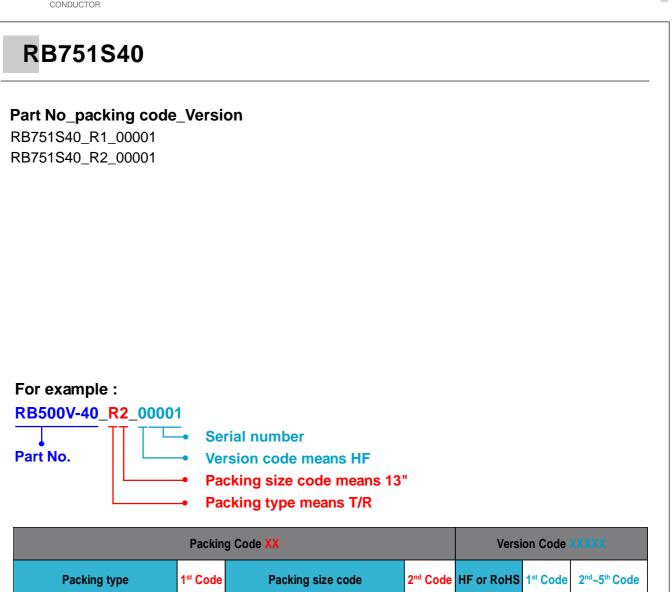
ORDER INFORMATION

Packing information

T/R - 12K per 13" plastic Reel

T/R - 5K per 7" plastic Reel





Packing type	1 st Code	Packing size code	2 nd Code	HF or RoHS	1 st Code	2 nd ~5 th Code
Tape and Ammunition Box (T/B)	Α	N/A	0	HF	0	serial number
Tape and Reel (T/R)	R	7"	1	RoHS	1	serial number
Bulk Packing (B/P)	В	13"	2			
Tube Packing (T/P)	т	26mm	X			
Tape and Reel (Right Oriented) (TRR)	S	52mm	Y			
Tape and Reel (Left Oriented) (TRL)	L	PANASERT T/B CATHODE UP (PBCU)	U			
FORMING	F	PANASERT T/B CATHODE DOWN (PBCD)	D			





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